

Customer Information Notification

202304012I: MKE17/13/12Z256/128VLL7 Final Test Site Expansion from NXP-ATTJ B2 to NXP-ATKL

Note: This notice is NXP Company Proprietary.

Issue Date: Jun 09, 2023 Effective date: Jun 10, 2023

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For detailed information we invite you to view this notification online

Management summary

Final Test site expansion for the MKE17/13/12Z256/128VLL7 14x14 100LQFP to the NXP-ATKL, Kuala Lumpur, Malaysia Final Test site.

Change Category

Uswafer Fab Process	[]Assembly Process	[]Product Marking	[]Test Process	[]Design
[]Wafer Fab Materials	[]Assembly Materials	[]Mechanical Specification	[]Test Equipment	[]Errata
[]Wafer Fab Location	[]Assembly Location	[]Packing/Shipping/Labeling	[X]Test Location	[]Electrica spec./Test coverage
[]Firmware	[]Other			

PCN Overview

Description

NXP Semiconductors announces the Final Test site expansion for the MKE17/13/12Z256/128VLL7 14X14 100LQFP associated with this notification, from the current NXP-ATTJ B2, Tianjin, China Final Test site to the NXP-ATKL, Kuala Lumpur, Malaysia Final Test site. The associated Test Backend Shipping / Packing Operations expand to the NXP-ATKL site as well.

Final Test site expansion was successfully qualified adhering to NXP specifications.

Please see the attached file(s) for additional details.

Reason

Qualification of NXP-ATKL, Kuala Lumpur, Malaysia is required for manufacturing flexibility and customer supply assurance.

Identification of Affected Products

Product identification does not change

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No Impact on form, fit, function, reliability or quality

Disposition of Old Products

NXP-ATKL will be an additional final test site. Products may continue to be tested at NXP-ATTJ as well.

Additional information

Additional documents: view online

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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Position Product Engineer

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At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards. Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

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NXP Semiconductors

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Orderable Part Number#	12NC	Product Type	Product Description	Package Outline	Package Description	Product Status	Customer Specific Indicator	Product Line
MKE17Z256VLL7	935420892557	MKE17Z256VLL7	MT256X, 100LQFP	(L)QFP100	SOT407-3	RFS	No	BLM1
MKE17Z128VLL7	935428656557	MKE17Z128VLL7	MT256X, 100LQFP	(L)QFP100	SOT407-3	RFS	No	BLM1
MKE13Z256VLL7	935428654557	MKE13Z256VLL7	MT256X, 100LQFP	(L)QFP100	SOT407-3	RFS	No	BLM1
MKE13Z128VLL7	935428652557	MKE13Z128VLL7	MT256X, 100LQFP	(L)QFP100	SOT407-3	RFS	No	BLM1
MKE12Z256VLL7	935429988557	MKE12Z256VLL7	MT256X, 100LQFP	(L)QFP100	SOT407-3	RFS	No	BLM1
MKE12Z128VLL7	935429986557	MKE12Z128VLL7	MT256X, 100LQFP	(L)QFP100	SOT407-3	RFS	No	BLM1